Absolute Maximum Ratings ( $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ )

| Parameter | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Collector Base Voltage | - $\mathrm{V}_{\text {cbo }}$ | 60 | V |
| Collector Emitter Voltage | -Vceo | 50 | V |
| Emitter Base Voltage | - $\mathrm{V}_{\text {Ebo }}$ | 6 | V |
| Collector Current Collector Current (Pulse) | - - | 3 | A |
| Collector Current (Pulse) | -lcp | 6 | A |
| Collector Power Dissipation | Pc | $\begin{gathered} \hline 0.5^{11} \\ 1^{2)} \\ \hline \end{gathered}$ | W |
| Junction Temperature | $\mathrm{T}_{\mathrm{j}}$ | 150 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $\mathrm{T}_{\text {stg }}$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |

## Thermal Characteristics

| Parameter | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Thermal Resistance from Junction to Ambient | ReנA | $250^{1)}$ | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

[^0]Characteristics at $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$

| Parameter |  | Symbol | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ```DC Current Gain at - VCE =2 V, - IC = 100 mA Current Gain Group at - V CE = 2 V, - - = = 3 A``` | $\begin{aligned} & \text { A } \\ & \text { B } \\ & \text { C } \end{aligned}$ | $h_{\text {fe }}$ <br> hfe <br> hfe <br> hfe | $\begin{gathered} 100 \\ 140 \\ 200 \\ 35 \\ \hline \end{gathered}$ |  | $\begin{aligned} & 200 \\ & 280 \\ & 400 \end{aligned}$ |  |
| Collector Base Cutoff Current at $-V_{C B}=40 \mathrm{~V}$ |  | -Ісво | - | - | 1 | $\mu \mathrm{A}$ |
| Emitter Base Cutoff Current at $-V_{E B}=4 \mathrm{~V}$ |  | -IEbo | - | - | 1 | $\mu \mathrm{A}$ |
| Collector Base Breakdown Voltage at $-\mathrm{lc}=100 \mu \mathrm{~A}$ |  | $-\mathrm{V}_{\text {(BR) }}$ cbo | 60 | - | - | V |
| Collector Emitter Breakdown Voltage at $-\mathrm{I}_{\mathrm{c}}=10 \mathrm{~mA}$ |  | $-\mathrm{V}_{\text {(BR) }}$ ceo | 50 | - | - | V |
| Emitter Base Breakdown Voltage at $-I_{E}=100 \mu \mathrm{~A}$ |  | $-\mathrm{V}_{(\mathrm{BR})}$ )BO | 6 | - | - | V |
| Collector Emitter Saturation Voltage at $-I_{C}=2 \mathrm{~A},-I_{\mathrm{B}}=100 \mathrm{~mA}$ |  | $-\mathrm{V}_{\mathrm{CE} \text { (sat) }}$ | - | - | 0.7 | V |
| Base Emitter Saturation Voltage at $-\mathrm{Ic}_{\mathrm{c}}=2 \mathrm{~A},-\mathrm{I}_{\mathrm{B}}=100 \mathrm{~mA}$ |  | $-\mathrm{V}_{\mathrm{BE} \text { (sat) }}$ | - | - | 1.2 | V |
| $\begin{aligned} & \text { Transition Frequency } \\ & \text { at }-\mathrm{V}_{\mathrm{CE}}=10 \mathrm{~V},-\mathrm{IC}_{\mathrm{C}}=50 \mathrm{~mA} \end{aligned}$ |  | $\mathrm{f}_{T}$ | - | 150 | - | MHz |
| Collector Output Capacitance at $-\mathrm{V}_{\mathrm{CB}}=10 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ |  | Cob | - | 30 | - | pF |
| Turn on Time <br> at $-\mathrm{V}_{\mathrm{cc}}=10 \mathrm{~V},-\mathrm{I}_{\mathrm{c}}=500 \mathrm{~mA},-\mathrm{I}_{\mathrm{B} 1}=-\mathrm{I}_{\mathrm{B} 2}=50 \mathrm{~mA}$ |  | ton | - | 40 | - | ns |
| Turn off Time at $-\mathrm{V}_{\mathrm{CC}}=10 \mathrm{~V},-\mathrm{I}_{\mathrm{C}}=500 \mathrm{~mA},-\mathrm{I}_{\mathrm{B} 1}=-\mathrm{l}_{\mathrm{B} 2}=50 \mathrm{~mA}$ |  | toff | - | 450 | - | ns |

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## Electrical Characteristics Curves

Fig. 1 Output Characteristics Curve


Fig. 3 hfe vs. Collector Current


Fig. 2 Collector Curren vs. Vbe


Fig. $4 \mathrm{~V}_{\mathrm{BE}(\text { sat) }}$ vs. Collector Current


## Electrical Characteristics Curves

Fig. $5 \mathrm{~V}_{\text {CE(sat) }}$ vs. Collector Current


Fig 6. Output Capacitance


Fig . 7 Power Derating Curve


## Package Outline (Dimensions in mm)



SOT-89


| Unit | A | bp | C | D | E | F | HE | e | L | L1 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 1.6 | 1.60 | 0.5 | 4.6 | 2.6 | 0.45 | 4.25 | 1.5 | 1.05 | 0.51 |
|  | 1.4 | 1.50 | 0.3 | 4.4 | 2.4 | 0.35 | 3.75 | typ. | 0.95 | 0.41 |

## Recommended Soldering Footprint



## Packing information

| Package | Tape Width <br> $(\mathrm{mm})$ | Pitch |  | Reel Size |  | Per Reel Packing Quantity |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | mm | inch | mm | inch |  |
| SOT-89 | 12 | $8 \pm 0.1$ | $0.315 \pm 0.004$ | 178 | 7 | 1,000 |
|  |  |  |  | 330 | 13 | 4,000 |

## Marking information

" 2SB1124*U " = Part No. (" * " Current Gain Group Code)
"YM" = Date Code Marking
" Y " = Year
" M " = Month
Font type: Arial



[^0]:    ${ }^{1)}$ Device mounted on FR-4 substrate PC board, 2 oz copper, with minimum recommended pad layout.
    ${ }^{2)}$ Device mounted on FR-4 substrate PC board, 2 oz copper, with 1 -inch square copper plate in still air.

